Chipcon AS
Gaustadalléen 21
N-0349 OSLO

Confirmation of environmental compatibility for supplied products

By authentic signing of this document, we confirm that CC1000 including package do not or only contain a maximum concentration of 0,1% by weight in homogeneous materials for the following substances

Lead and lead compounds,
Mercury and mercury compounds,
Hexavalent chromium,
Polybrominated biphenyls (PBB),
Polybrominated biphenyl ethers (PBDE)

and a maximum concentration of 0,01% by weight in homogeneous materials for

Cadmium and cadmium compounds,

which are banned by Directive 2002/95/EC of 27 January 2003 (RoHS) and updated by Commission Decision of 18 August 2005.

Confirmation:

31/10/2005
(Date)

Viggo Grønli, Product Manager
(Name, Function)

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Mailing Address: Texas Instruments
Post Office Box 655303 Dallas, Texas 75265

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